DFI600HF17I4RE1

1700V/600A Half Bridge IGBT Module

Description

The DFI600HF17I4RE1 is a Half Bridge IGBT Power Module. It integrates high performance IGBT chips designed for the applications such as High Power supply and Motor control.

Features

- Blocking voltage:1700V
- Low saturation voltage $V_{CE(sat)}$
- Low Switching Losses
- 150°C maximum junction temperature
- Thermistor inside

Applications

- High Power Switching Applications
- Motor Drives
- Solar inverter Systems
- Wind Turbines

Circuit diagram

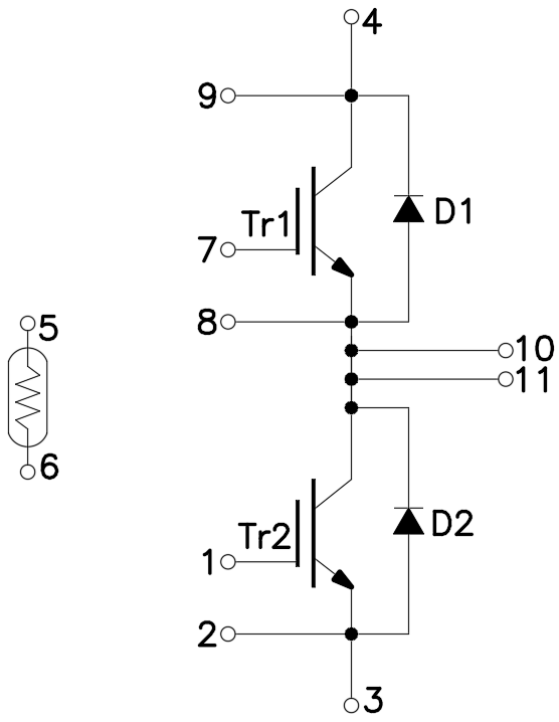

Figure 1. Out drawing & circuit diagram for DFI600HF17I4RE1

Pin Configuration and Marking Information

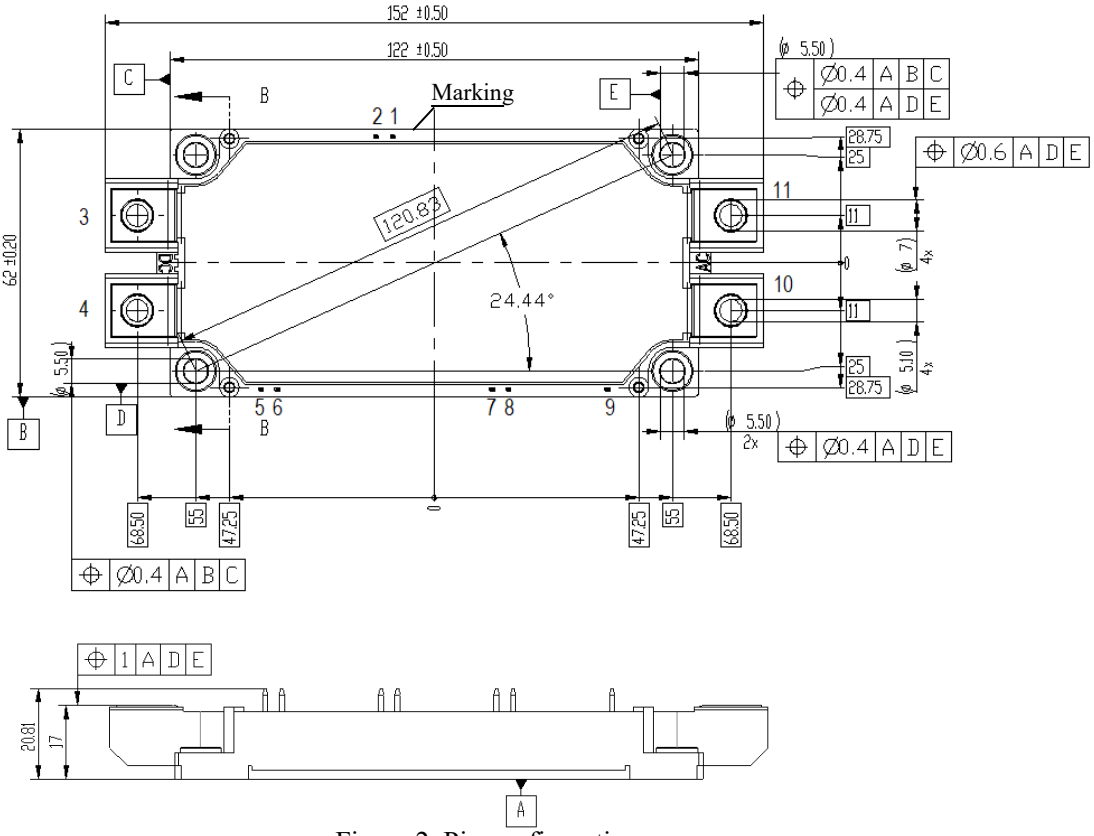

Figure 2. Pin configuration

Module

Parameter	Conditions	Value	Unit
Isolation Voltage	RMS, f = 50Hz, t =1min	3.4	KV
Material of module baseplate	-	Cu	-
Creepage distance	terminal to heatsink terminal to terminal	14.5 13	mm
Clearance	terminal to heatsink terminal to terminal	12.5 10	mm
CTI	-	>225	-
Module lead resistance, terminals–chip	T_C =25°C	0.8	mΩ
Mounting torque for module mounting	M5, M6	3 to 6	Nm
Weight	-	420	g

Maximum Ratings (T_j=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-Emitter Voltage	G-E Short	1700	V
V_{GES}	Gate-Emitter Voltage	C-E Short	±20	V
I_C	DC Continuous Collector Current	T_C=100°C	650	A
I_{CM}	Pulse Collector Current	t_p=1ms, Note1	1300	A
P_C	Maximum Power Dissipation	T_C=25°C, T_j=150°C(IGBT)	3906	W
I_F	Diode Forward Current	-	650	A
I_{FRM}	Repetitive peak forward Current	t_p=1ms, Note1	1300	A
I^2t	I^2t-value	V_R=0V, t_p=10ms, T_j=125°C (Diode)	36000	A^2s
T_j	junction temperature	-	-40 to 150	°C
T_{stg}	Storage temperature	-	-40 to 125	°C

Note1: Pulse width limited by maximum junction temperature

NTC characteristics

Symbol	Parameter	Condition	Value			Unit
			Min.	Typ.	Max.	
R_{25}	Resistance	T_C=25°C	-	5	-	kΩ
ΔR/R	Deviation of R100	T_C=100°C, R_{100}=493Ω	5	-	5	%
P_{25}	Power dissipation	T_C=25°C	-	-	20	mW
$B_{25/50}$	B-value	R2 = R25 exp [$B_{25/50}$(1/T2 - 1/(298,15 K))]	-	3375	-	K
$B_{25/80}$	B-value	R2 = R25 exp [$B_{25/80}$(1/T2 - 1/(298,15 K))]	-	3411	-	K
$B_{25/100}$	B-value	R2 = R25 exp [$B_{25/100}$(1/T2 - 1/(298,15 K))]	-	3433	-	K

IGBT Electrical characteristics (T_j=25°C unless otherwise specified, chip: Target)

Symbol	Item	Condition		Value			Unit
				Min.	Typ.	Max	
$V_{CE(sat)}$ (Chip)	Collector-Emitter Saturation Voltage	I_C=600A, V_{GE}=15V	T_j=25°C	-	1.6	1.9	V
			T_j=125°C	-	1.95	-	V
			T_j=150°C	-	2.03	-	V
$V_{GE(th)}$	Gate-Emitter threshold Voltage	I_C=24mA, V_{CE}=V_{GE}		5.2	5.8	6.4	V
Q_G	Gate charge	V_{GE}= -15V to +15V		-	6.2	-	uC
R_{Gint}	Internal gate resistor	-	T_j=25°C	-	1.7	-	Ω
C_{ies}	Input Capacitance	V_{CE}=25V, V_{GE}=0V, f=1MHz	T_j=25°C	-	49.5	-	nF
C_{res}	Reverse transfer Capacitance			-	0.75	-	nF
I_{CES}	Collector- Emitter Cut off Current	V_{CE}=1700V, V_{GE}=0V	T_j=25°C	-	-	1	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE}=20V, V_{CE}=0V	T_j=25°C	-	-	1.8	uA
$t_{d(on)}$	Turn-on delay time	V_{CC}=900V, I_C=600A, V_{GE}=+15V/-8V, R_G=1.0Ω, Inductive load	T_j=25°C	-	205	-	ns
			T_j=150°C	-	207	-	
t_r	Rise time		T_j=25°C	-	125	-	ns
			T_j=150°C	-	188	-	
$t_{d(off)}$	Turn-off delay time		T_j=25°C	-	570	-	ns
			T_j=150°C	-	735	-	
t_f	Fall time		T_j=25°C	-	370	-	ns
			T_j=150°C	-	680	-	
E_{on}	Turn-on power dissipation		T_j=25°C	-	234	-	mJ
			T_j=150°C	-	383	-	
E_{off}	Turn-off power dissipation		T_j=25°C	-	134	-	mJ
			T_j=150°C	-	205	-	
I_{SC}	SC data	V_{GE}<15V, V_{CC}=1000V	T_j=150°C, t_p<10us	-	3000	-	A
$R_{th(j-c)}$	Thermal Resistance, Junction to Case (IGBT)			-	0.032	-	°C /W
$R_{th(c-s)}$	Thermal Resistance, Case to sink (Conductive Grease applied)			-	0.015	-	°C /W

Freewheeling Diode Electrical characteristics (Tj=25°C unless otherwise specified, chip: Target)

Symbol	Item	Condition		Value			Unit
				Min.	Typ.	Max	
V_F	Diode Forward Voltage	I_F=600A V_{GE}=0V	T_j=25°C	-	1.8	2.1	V
			T_j=150°C	-	1.75	-	
t_{rr}	Reverse recovery time	(Switch side) V_{CC}=900V, I_C=600A V_{GE}=+15V/-8V R_G=1.0Ω (FRD side) V_{rr}=900V, I_F=600A V_{GE}=+15V/-8V Inductive load switching operation	T_j=25°C	-	1.08	-	us
			T_j=150°C	-	1.51	-	
I_{RM}	Peak reverse recovery Current		T_j=25°C	-	270	-	A
			T_j=150°C	-	333	-	
Q_{rr}	Recovered charge		T_j=25°C	-	112	-	uC
			T_j=150°C	-	244	-	
E_{rr}	Reverse recovered energy		T_j=25°C	-	53	-	mJ
			T_j=150°C	-	125	-	
$R_{th(j-c)}$	Thermal Resistance, Junction to Case (Diode)			-	0.042	-	°C/W
$R_{th(c-s)}$	Thermal Resistance, Case to sink (Conductive Grease applied)			-	0.015	-	°C/W

Test Conditions

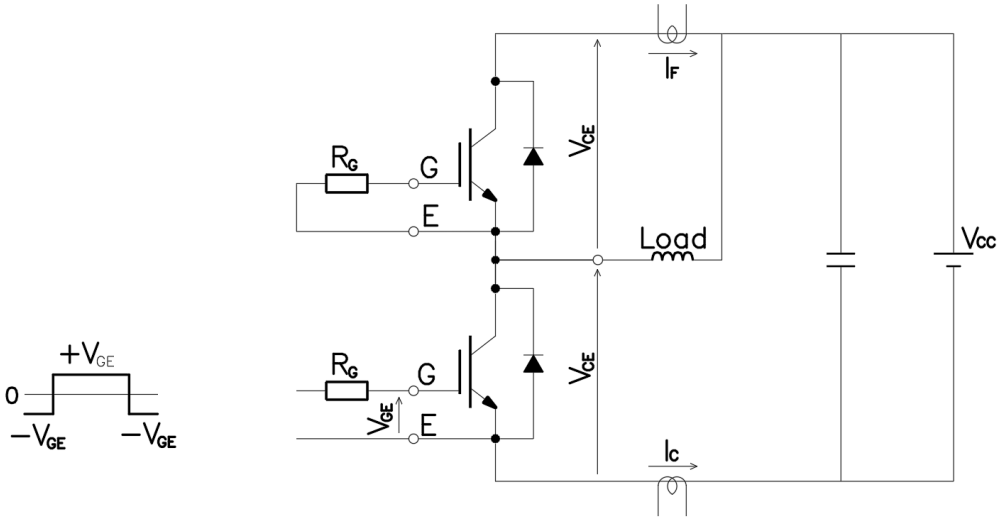

Figure 3. Switching time measure circuit

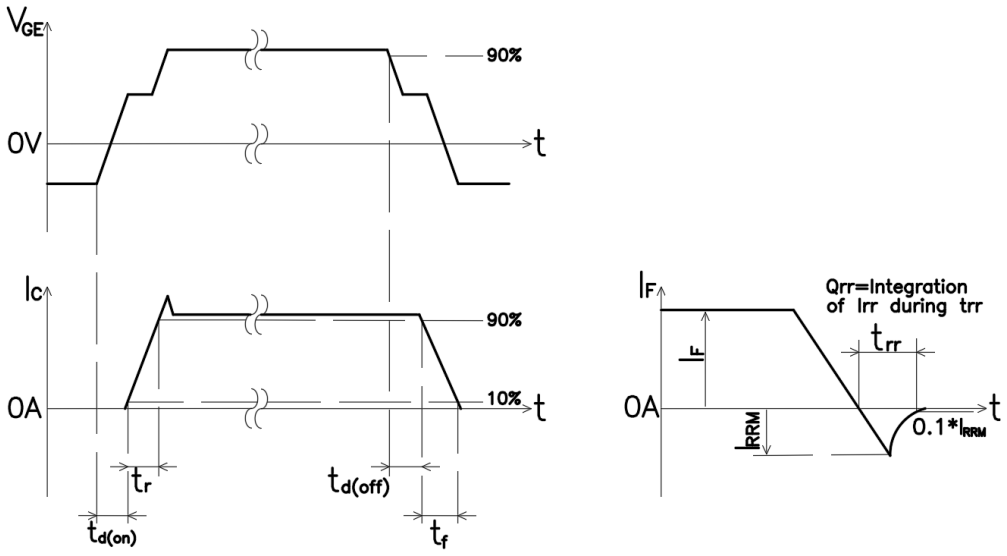

Figure 4. Switching time definition

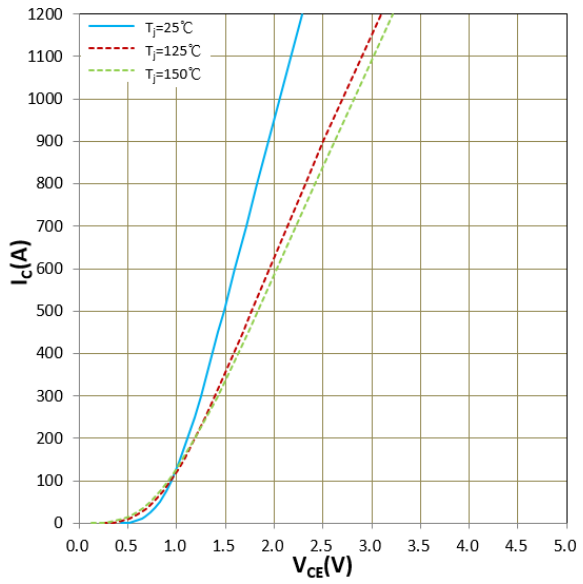

Figure 5. Ic vs V_{CE}
V_{GE}=15V

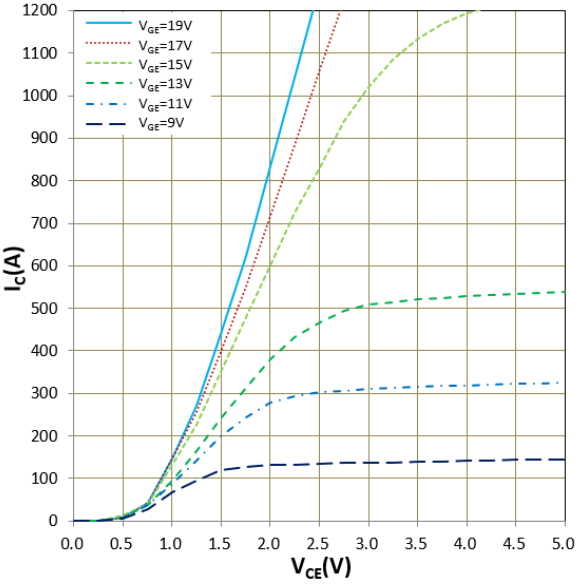

Figure 6. Ic vs V_{CE}
T_j=150°C

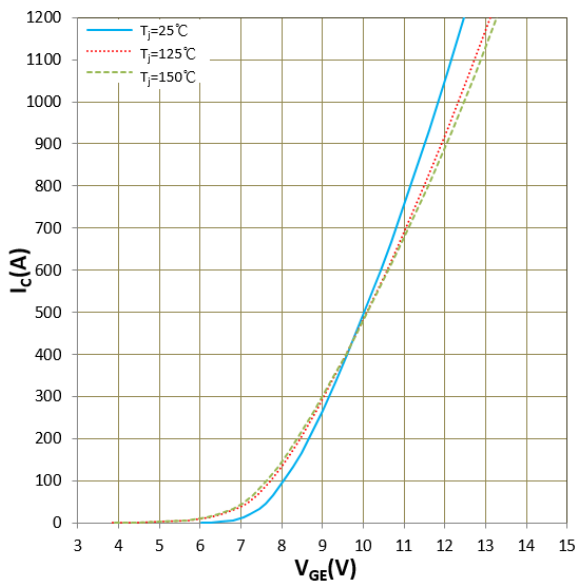

Figure 7. Ic vs V_{GE}
V_{CE} =20V

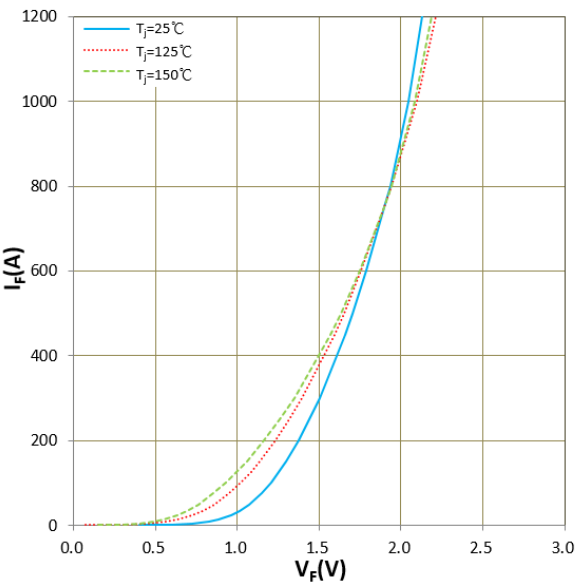

Figure 8. I_F vs V_F

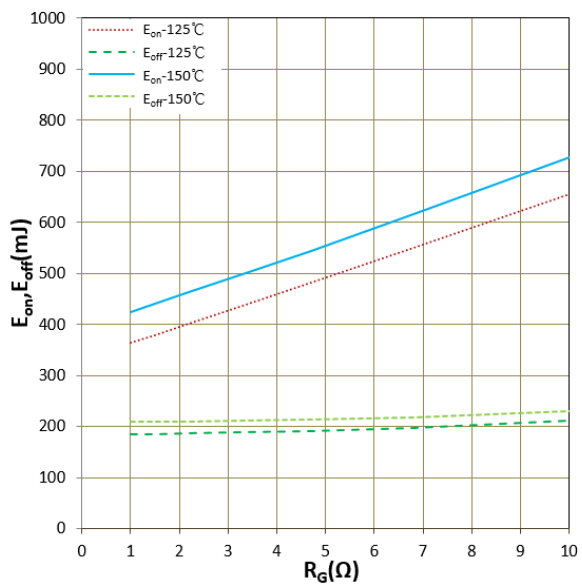

Figure 9. E_{on}, E_{off} vs R_G(Typ)
V_{CC} =900V, V_{GE} =+15V/-8V, I_C = 600A
Inductive Load

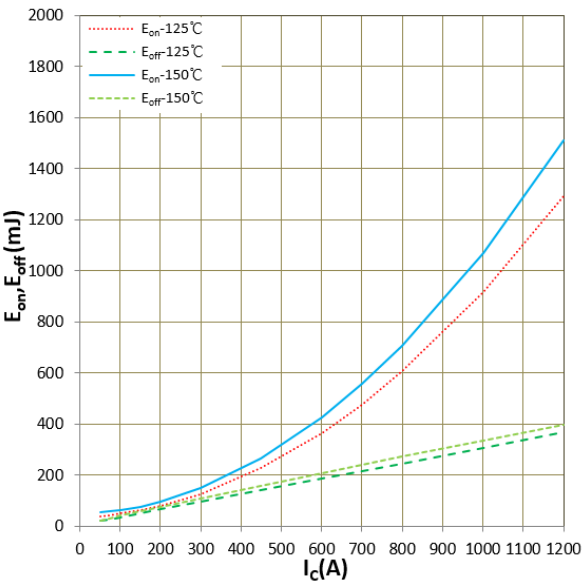

Figure 10 E_{on}, E_{off} vs Ic(Typ)
V_{CC}=900V, V_{GE} =+15V/-8V, R_G =1.0Ω
Inductive Load

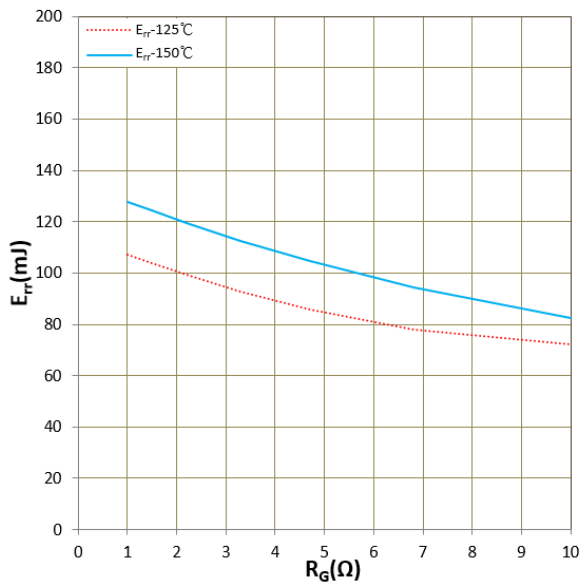

Figure 11. Err vs R_G(Typ)
V_{CC} =900V, V_{GE} =+15V/-8V, I_F =600A
Inductive Load

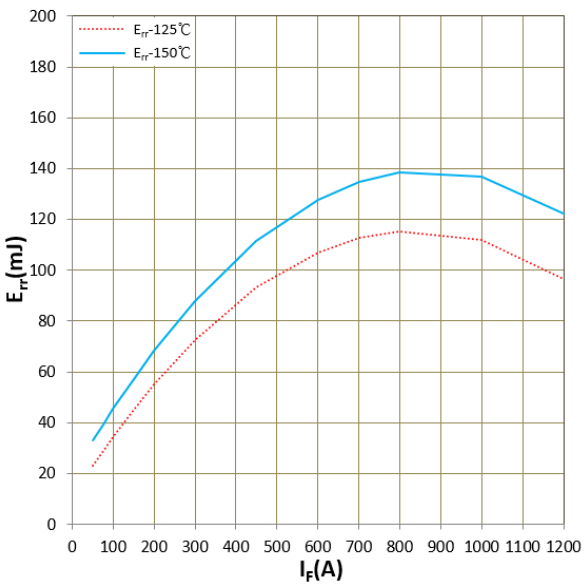

Figure 12. E_{rr} vs I_F(Typ)
V_{CC} =900V, V_{GE} =+15V/-8V, R_G =1.0Ω
Inductive Load

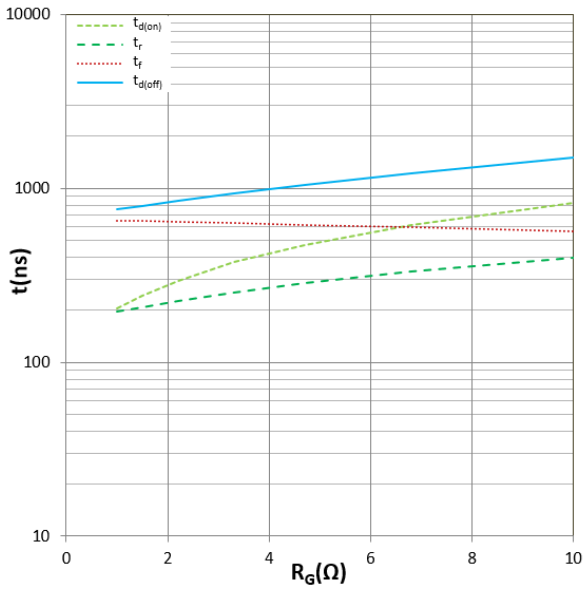

Figure 13. Switching time vs R_G(Typ)
V_{CC} =900V, V_{GE} =+15V/-8V, I_C =600A
T_j =150°C, Inductive Load

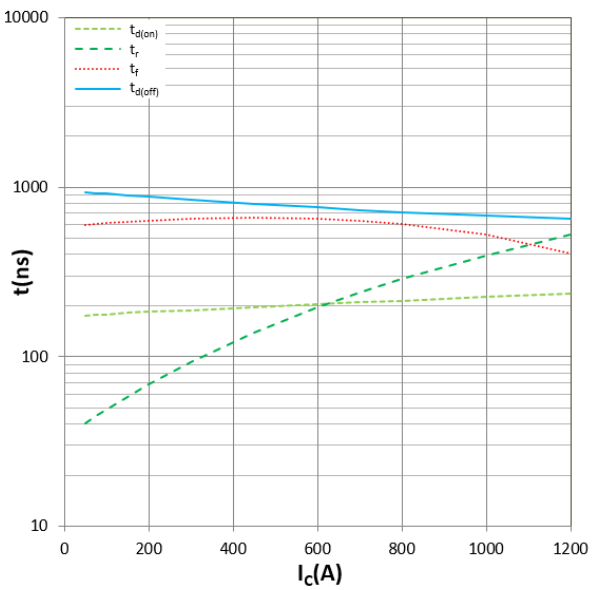

Figure 14. Switching time vs Ic(Typ)
V_{CC} =900V, V_{GE} =+15V/-8V, R_G =1.0Ω
T_j =150°C , Inductive Load

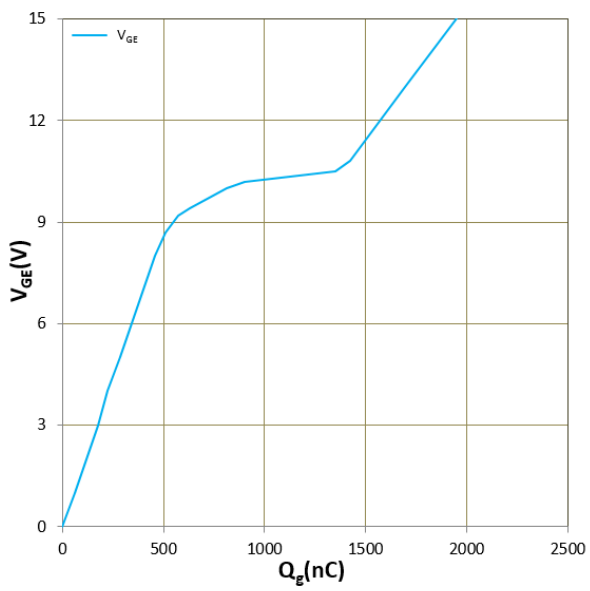

Figure 15. Gate charge

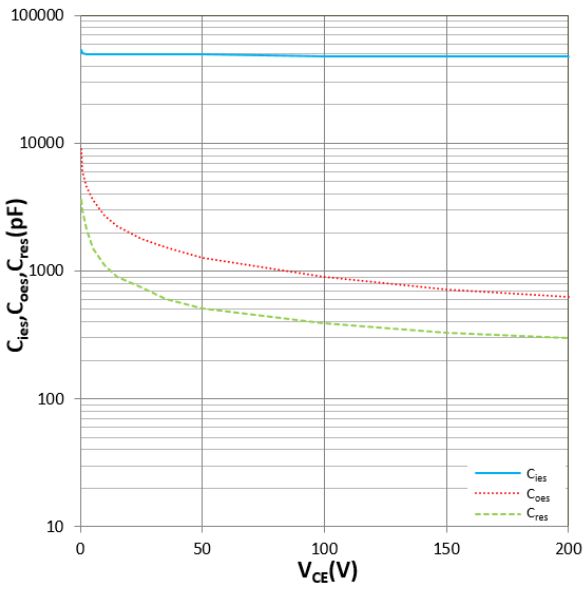

Figure 16. C_{ies}, C_{oes}, C_{res} vs V_{CE}
T_j =25°C, f =1MHz

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